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(71) Applicant
 Nippon Mektron Ltd.
 (Japan),
 Seiwa Building, 12-15
 Shiba Daimon 1-chome,
 Minato-ku, Tokyo, Japan

(72) Inventors
 Katsuyuki Yatabe,
 Seiji Toke

(74) Agent and/or Address for
 Service
 Frank B. Dehn and Co.,
 Imperial House, 15-19
 Kingsway, London
 WC2B 6UZ

(54) Flexible circuit board

(57) A flexible circuit board comprises
 a base film 1 with a circuit pattern 2
 thereon, a cover film 3 over part of the
 circuit pattern which leaves an

exposed connection portion 2A of the
 circuit pattern, and stress relief
 apertures 5, 6 in the cover film and/or
 the base film adjacent the edge 4 of
 the cover film to prevent stress
 concentrations which cause breaking
 of the circuit pattern.

*Φ mention des
types de connexions.*

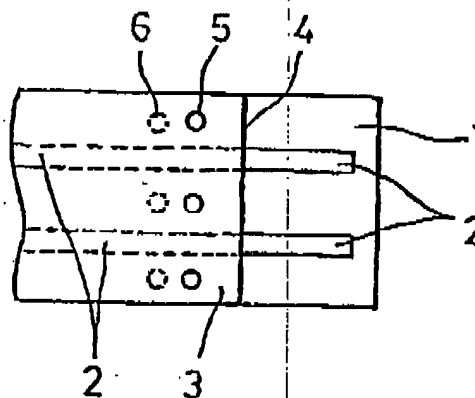


FIG. 3

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